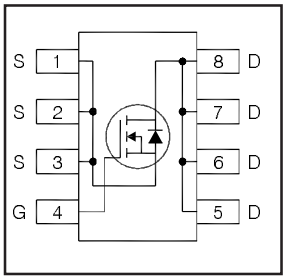
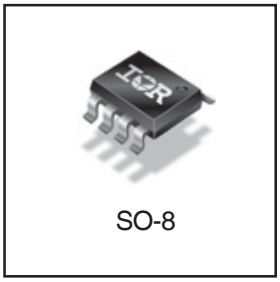
International
IOR Rectifier

IRF6201PbF

HEXFET® Power MOSFET

V_{DS}	20	V
$R_{DS(on)\ max}$ (@V_{GS} = 4.5V)	2.45	mΩ
$R_{DS(on)\ max}$ (@V_{GS} = 2.5V)	2.75	mΩ
$Q_{g\ (typical)}$	130	nC
I_D (@T_A = 25°C)	27	A





Applications

- OR-ing or hot-swap MOSFET
- Battery operated DC motor inverter MOSFET
- System/Load switch

Features and Benefits

Features		Benefits
Low R_{DSon} (≤ 2.45mΩ @ Vgs = 4.5V)	results in ⇒	Lower conduction losses
Industry-standard SO-8 package		Multi-vendor compatibility
RoHS compliant containing no lead, no bromide and no halogen		Environmentally Friendly

Orderable part number	Package Type	Standard Pack		Note
		Form	Quantity	
IRF6201PbF	SO8	Tube/Bulk	95	
IRF6201TRPbF	SO8	Tape and Reel	4000	

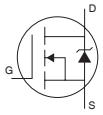
Absolute Maximum Ratings

	Parameter	Max.	Units
V_{DS}	Drain-to-Source Voltage	20	V
V_{GS}	Gate-to-Source Voltage	±12	
I_D @ T_A = 25°C	Continuous Drain Current, V_{GS} @ 4.5V	27	A
I_D @ T_A = 70°C	Continuous Drain Current, V_{GS} @ 4.5V	22	
I_{DM}	Pulsed Drain Current ①	110	
P_D @T_A = 25°C	Power Dissipation ③	2.5	W
P_D @T_A = 70°C	Power Dissipation ③	1.6	
	Linear Derating Factor	0.02	W/°C
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	°C

Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	20	—	—	V	V_{GS} = 0V, I_D = 250µA
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	4.6	—	mV/°C	Reference to 25°C, I_D = 1mA
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	1.90	2.45	mΩ	V_{GS} = 4.5V, I_D = 27A ②
		—	2.10	2.75		V_{GS} = 2.5V, I_D = 22A ②
$V_{GS(th)}$	Gate Threshold Voltage	0.5	—	1.1	V	V_{DS} = V_{GS}, I_D = 100µA
I_{DSS}	Drain-to-Source Leakage Current	—	—	1.0	µA	V_{DS} = 16V, V_{GS} = 0V
		—	—	150		V_{DS} = 16V, V_{GS} = 0V, T_J = 125°C
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	V_{GS} = 12V
	Gate-to-Source Reverse Leakage	—	—	-100		V_{GS} = -12V
Q_g	Total Gate Charge	—	130	195	nC	V_{GS} = 4.5V
Q_{gs}	Gate-to-Source Charge	—	16	—		V_{DS} = 10V
Q_{gd}	Gate-to-Drain Charge	—	60	—		I_D = 22A
$t_{d(on)}$	Turn-On Delay Time	—	29	—	ns	V_{DD} = 20V, V_{GS} = 4.5V
t_r	Rise Time	—	100	—		I_D = 1.0A
$t_{d(off)}$	Turn-Off Delay Time	—	320	—		R_G = 6.8Ω
t_f	Fall Time	—	265	—		See Figs. 10a & 10b
C_{iss}	Input Capacitance	—	8555	—	pF	V_{GS} = 0V
C_{oss}	Output Capacitance	—	1735	—		V_{DS} = 16V
C_{rss}	Reverse Transfer Capacitance	—	1290	—		f = 1.0MHz

Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current (Body Diode)	—	—	2.5	A	MOSFET symbol showing the integral reverse p-n junction diode. 
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	110		
V_{SD}	Diode Forward Voltage	—	—	1.2	V	T_J = 25°C, I_S = 2.5A, V_{GS} = 0V ②
t_{rr}	Reverse Recovery Time	—	82	120	ns	T_J = 25°C, I_F = 2.5A, V_{DD} = 16V
Q_{rr}	Reverse Recovery Charge	—	180	270	nC	di/dt = 100/µs ②

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JL}$	Junction-to-Drain Lead ④	—	20	°C/W
$R_{\theta JA}$	Junction-to-Ambient ③	—	50	

Notes:

① Repetitive rating; pulse width limited by max. junction temperature.

② Pulse width ≤ 400µs; duty cycle ≤ 2%.

③ When mounted on 1 inch square copper board.

④ R_θ is measured at T_J approximately 90°C.

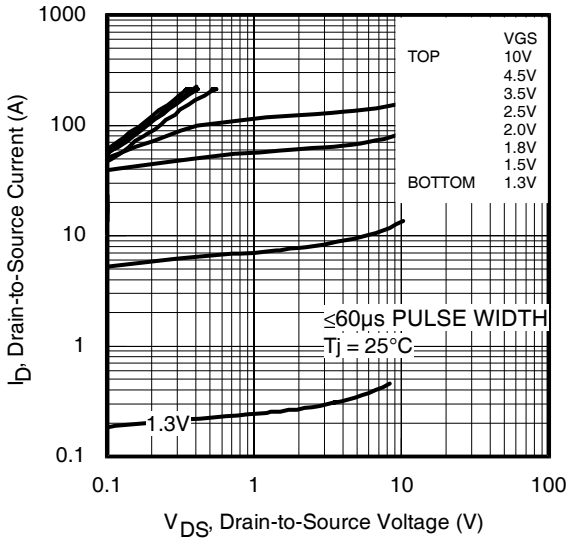


Fig 1. Typical Output Characteristics

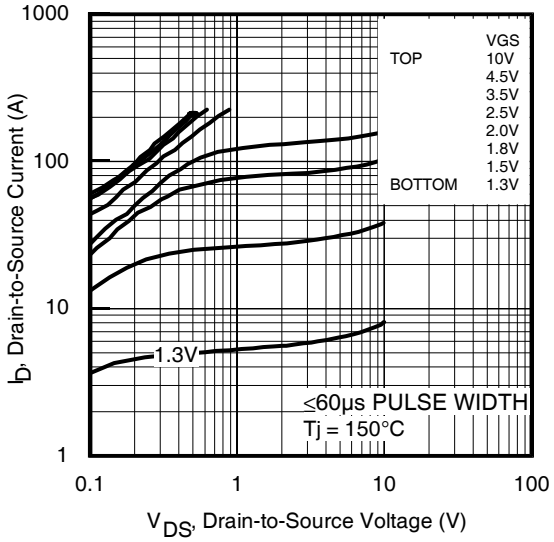


Fig 2. Typical Output Characteristics

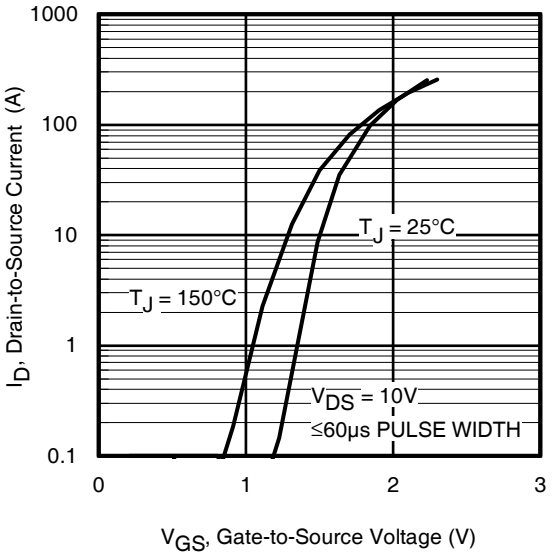


Fig 3. Typical Transfer Characteristics

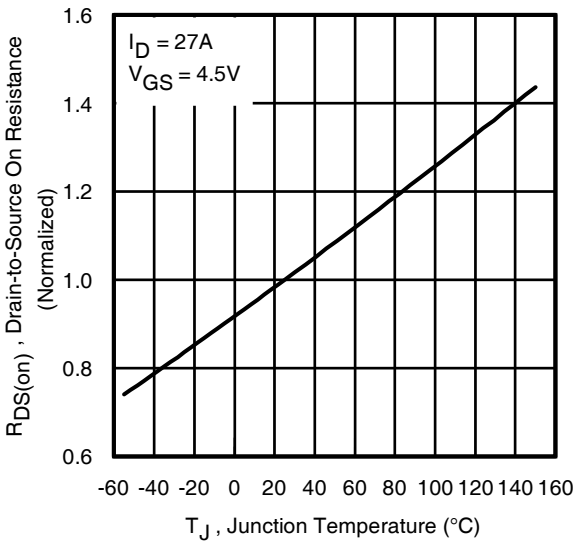


Fig 4. Normalized On-Resistance vs. Temperature

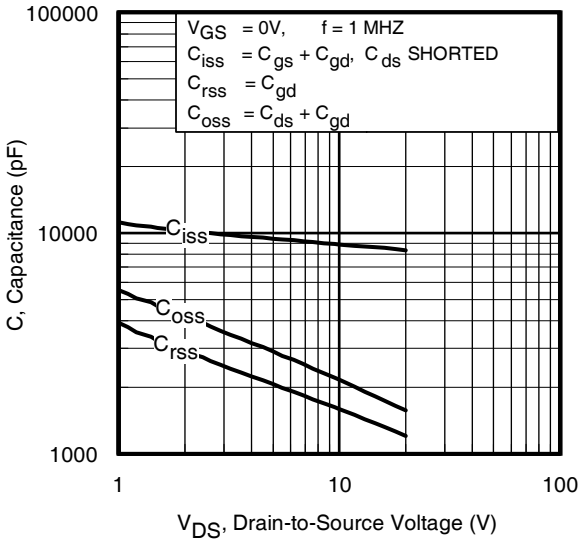


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

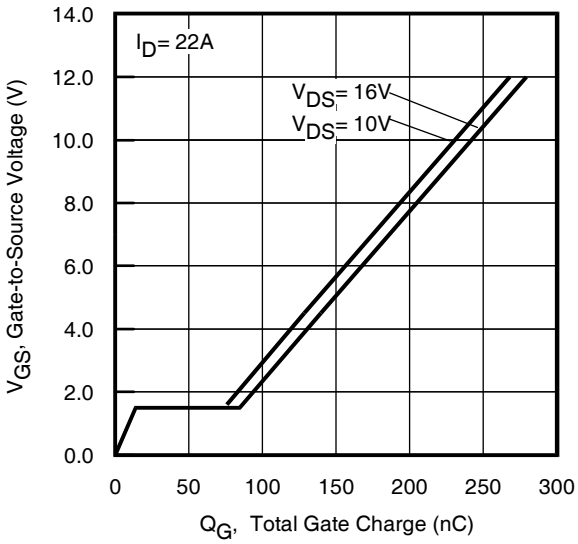


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

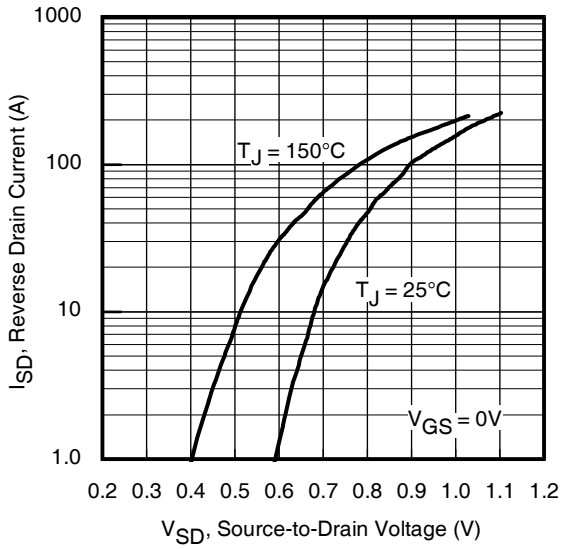


Fig 7. Typical Source-Drain Diode Forward Voltage

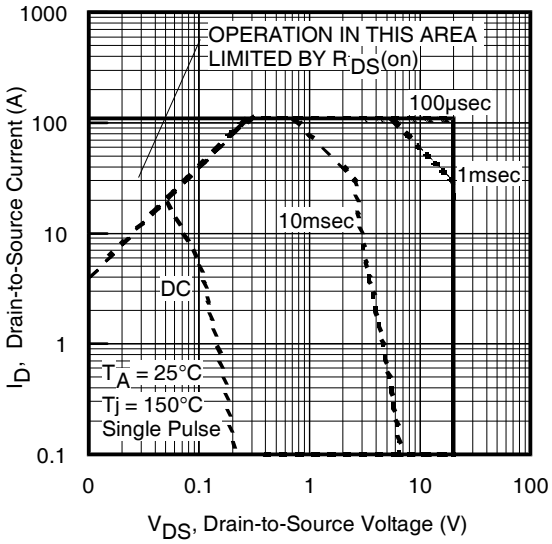


Fig 8. Maximum Safe Operating Area

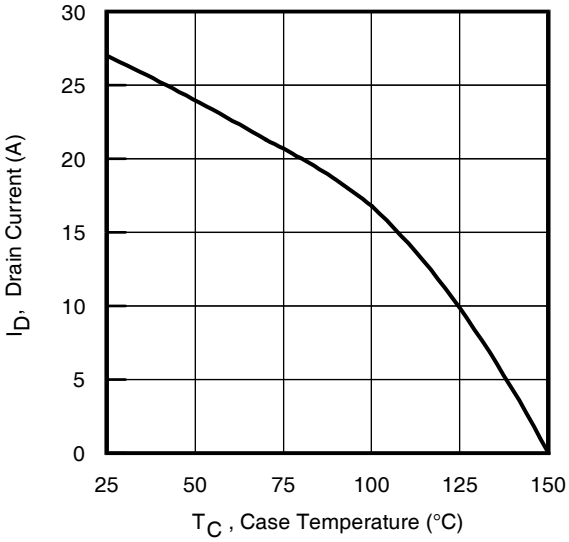


Fig 9. Maximum Drain Current vs. Case Temperature

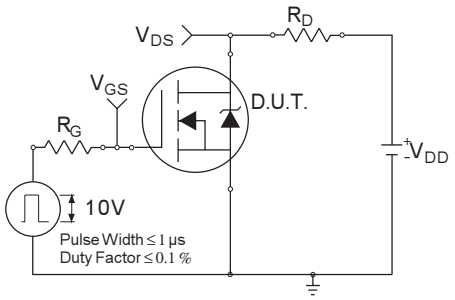


Fig 10a. Switching Time Test Circuit

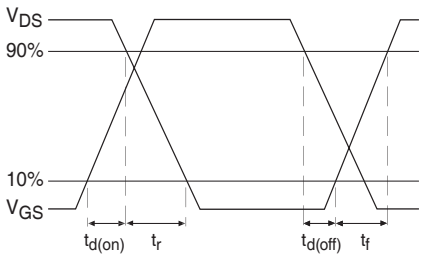


Fig 10b. Switching Time Waveforms

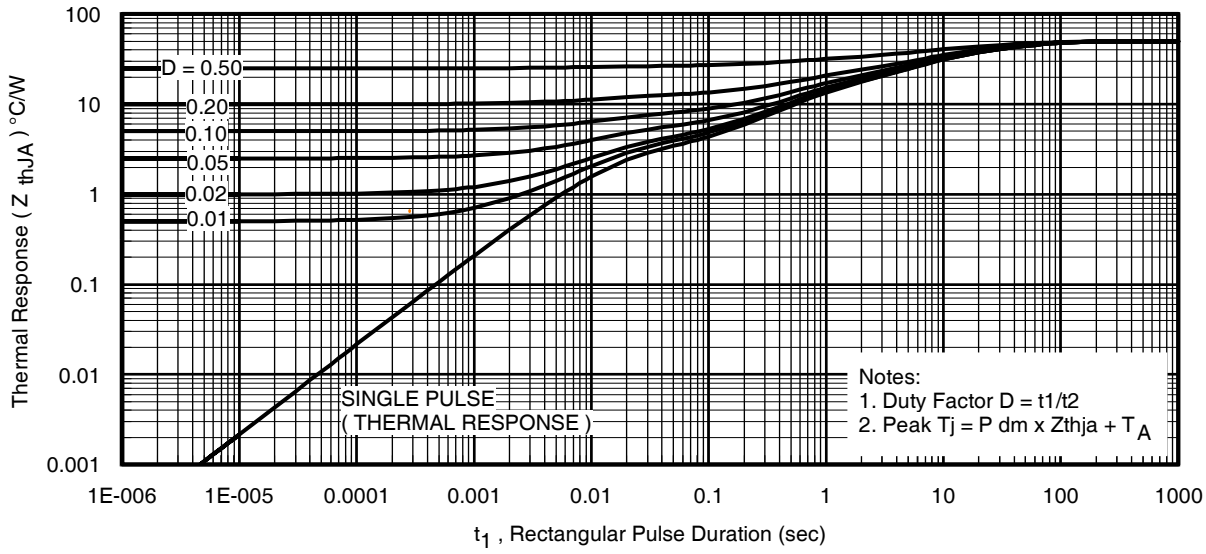


Fig 11. Typical Effective Transient Thermal Impedance, Junction-to-Ambient

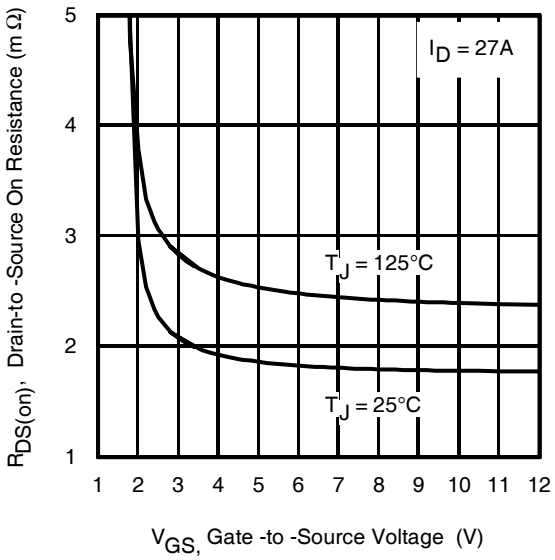


Fig 12. Typical On-Resistance vs. Gate Voltage

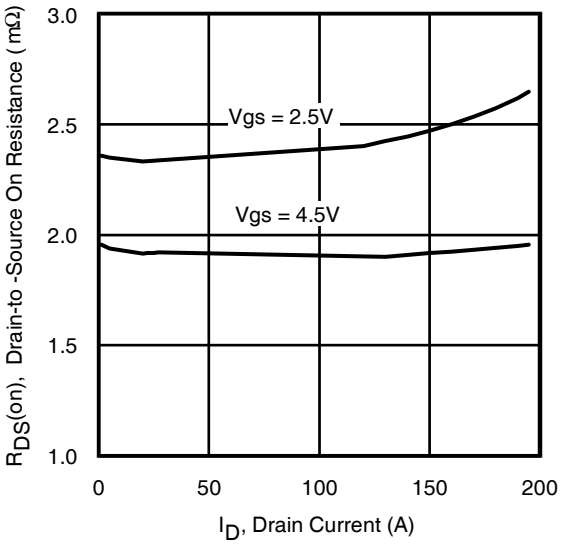


Fig 13. Typical On-Resistance vs. Drain Current

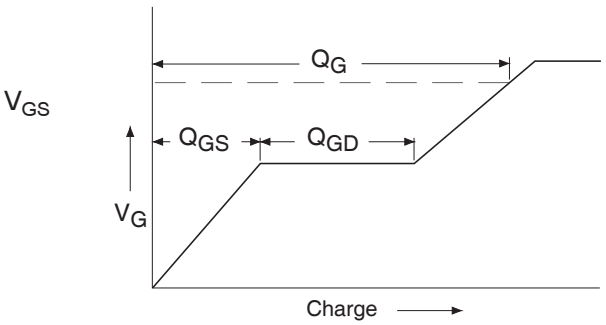


Fig 14a. Basic Gate Charge Waveform

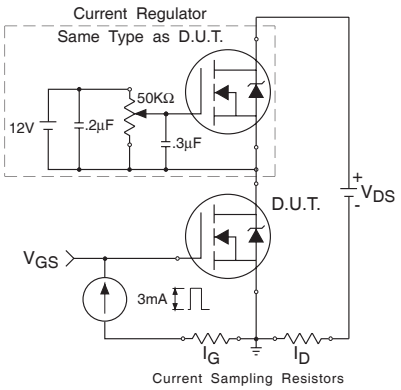


Fig 14b. Gate Charge Test Circuit

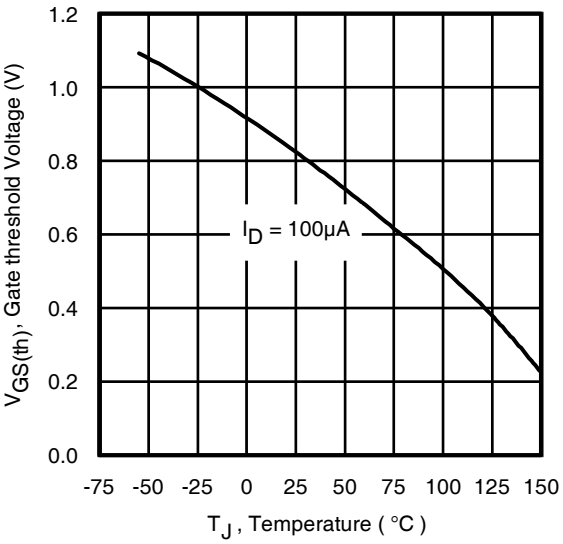


Fig 15. Typical Threshold Voltage vs. Junction Temperature

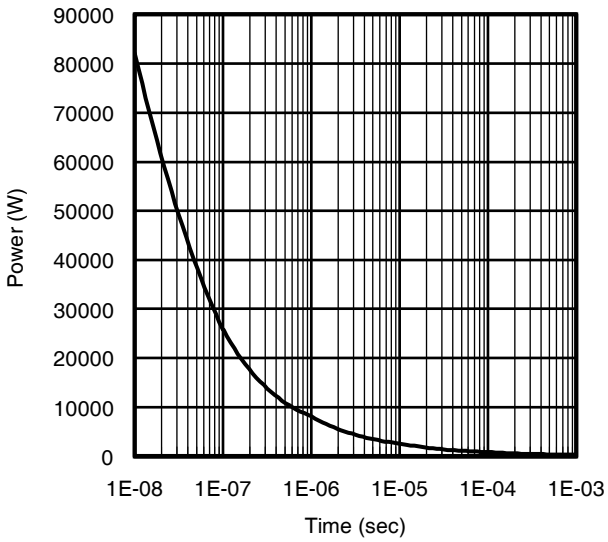
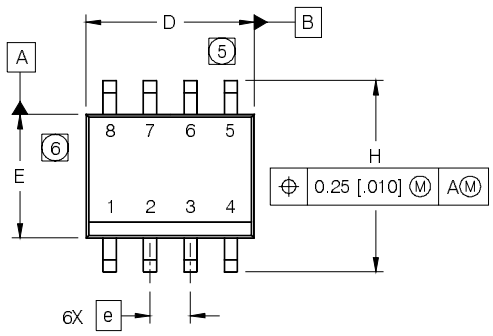


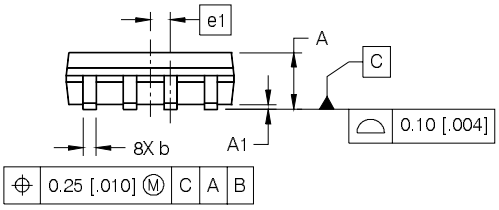
Fig 16. Typical Power vs. Time

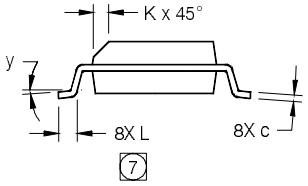
SO-8 Package Outline (Mosfet & Fetky)

Dimensions are shown in milimeters (inches)



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050 BASIC		1.27 BASIC	
e1	.025 BASIC		0.635 BASIC	
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°

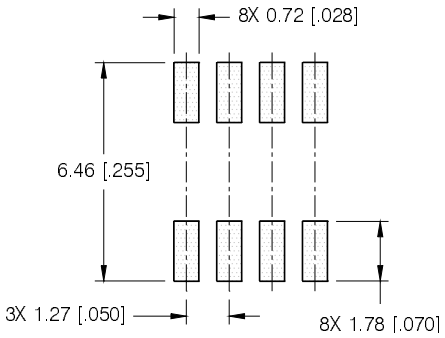




NOTES:

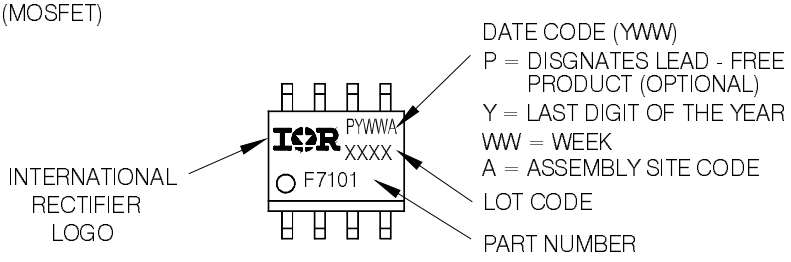
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
5. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 [.006].
6. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [.010].
7. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

FOOTPRINT



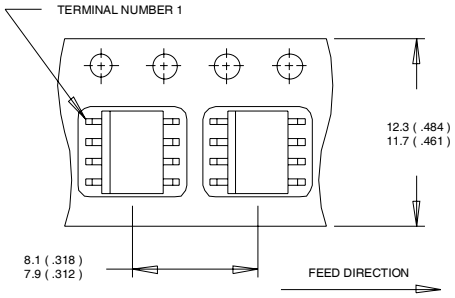
SO-8 Part Marking Information

EXAMPLE: THIS IS AN IRF7101 (MOSFET)

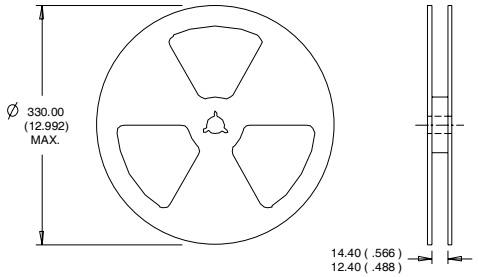


Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

SO-8 Tape and Reel



NOTES:
1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :
1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Qualification Information†

Qualification level	Consumer †† (per JEDEC JESD47F††† guidelines)	
Moisture Sensitivity Level	SO-8	MSL1 (per JEDEC J-STD-020D†††)
RoHS Compliant	Yes	

† Qualification standards can be found at International Rectifier's web site http://www.irf.com/product-info/reliability

†† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information: http://www.irf.com/whoto-call/salesrep/

††† Applicable version of JEDEC standard at the time of product release.

Data and specifications subject to change without notice.

International
IOR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
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